∽DELPHI SERIES



Delphi DNL, Non-Isolated Point of Load DC/DC Power Modules: 2.8-5.5Vin, 0.75-3.3V/16A out

The Delphi Series DNL, 2.8-5.5V input, single output, non-isolated Point of Load DC/DC converters are the latest offering from a world leader in power system and technology and manufacturing -- Delta Electronics, Inc. The DNL series provides a programmable output voltage from 0.75V to 3.3V using an external resistor. The DNL converters have flexible and programmable tracking and sequencing features to enable a variety of startup voltages as well as sequencing and tracking between power modules. This product family is available in a surface mount or SIP package and provides 16A of current in an industry standard footprint. With creative design technology and optimization of component placement, these converters possess outstanding electrical and thermal performance and extremely high reliability under highly stressful operating conditions.

DATASHEET DS_DNL04SIP16_10052006

FEATURES

- High efficiency: 95% @ 5.0Vin, 3.3V/16A out
 - Small size and low profile: (SIP) 50.8mm x 13.4mm x 8.5mm (2.00" x 0.53" x 0.33")
- Single-In-Line (SIP) packaging
- Standard footprint
- Voltage and resistor-based trim
- Pre-bias startup
- Output voltage tracking
- No minimum load required
- Output voltage programmable from 0.75Vdc to 3.3Vdc via external resistor
- Fixed frequency operation
- Input UVLO, output OTP, OCP
- Remote ON/OFF
- Remote sense
- ISO 9001, TL 9000, ISO 14001, QS9000, OHSAS18001 certified manufacturing facility
- UL/cUL 60950 (US & Canada) Recognized, and TUV (EN60950) Certified
- CE mark meets 73/23/EEC and 93/68/EEC directives

OPTIONS

- Negative On/Off logic
- Tracking feature
- SMD package

APPLICATIONS

- Telecom/DataCom
- Distributed power architectures
- Servers and workstations
- LAN/WAN applications
- Data processing applications





TECHNICAL SPECIFICATIONS

(T_A = 25°C, airflo<u>w rate = 300 LFM, V_{in} = 2.8Vdc and 5.5Vdc, nominal Vout unless otherwise noted.)</u>

PARAMETER	NOTES and CONDITIONS	DNL04S0A0R16PFA			
		Min.	Тур.	Max.	Units
ABSOLUTE MAXIMUM RATINGS Input Voltage (Continuous)		0		5.8	Vdc
Tracking Voltage		0		Vin,max	Vdc
Operating Temperature	Refer to Figure 45 for measuring point	-40		125	°C
Storage Temperature		-55		+125	°C
INPUT CHARACTERISTICS					
Operating Input Voltage	$Vo \leq Vin - 0.5$	2.8		5.5	V
Input Under-Voltage Lockout			0.0		
Turn-On Voltage Threshold Turn-Off Voltage Threshold			2.2 2.0		V
Maximum Input Current	Vin=2.8V to 5.5V, Io=Io,max		2.0	16	A
No-Load Input Current	VIII-2.0V to 0.0V, 10-10,110X		70	100	mA
Off Converter Input Current			20	30	mA
Inrush Transient	Vin=2.8V to 5.5V, Io=Io,min to Io,max			0.1	A ² S
Recommended Inout Fuse				20	Α
Input Reflected-Ripple Current	P-P thru 1µH inductor, 5Hz to 20MHz		TBD		mAp-p
Input Voltage Ripple Rejection	120 Hz		TBD		dB
OUTPUT CHARACTERISTICS				10.0	% Vo,set
Output Voltage Set Point Output Voltage Adjustable Range	Vin=5V, Io=Io, max	-2.0 0.7525	Vo,set	+2.0 3.63	V VO,SEL
Output Voltage Regulation		0.7525		5.05	V
Over Line	Vin=2.8V to 5.5V		0.3		% Vo,set
Over Load	lo=lo,min to lo,max		0.0		% Vo,set
Over Temperature	Ta=-40℃ to 85℃		0.8		% Vo,set
Total Output Voltage Range	Over sample load, line and temperature	-3.0		+3.0	% Vo,set
Output Voltage Ripple and Noise	5Hz to 20MHz bandwidth				
Peak-to-Peak	Full Load, 1µF ceramic, 10µF tantalum		25	50	mV
RMS	Full Load, 1µF ceramic, 10µF tantalum		8	15	mV
Output Current Range		0		16	A
Output Voltage Over-shoot at Start-up			000	5	% Vo,set
Output DC Current-Limit Inception Output Short-Circuit Current (Hiccup Mode)	lo,s/c		220 3.5	280	% Io Adc
DYNAMIC CHARACTERISTICS	10,5/C		3.5		Auc
Dynamic Load Response	10µF Tan & 1µF Ceramic load cap, 2.5A/µs				
Positive Step Change in Output Current	50% Io, max to 100% Io, max		300	400	mV
Negative Step Change in Output Current	100% Io, max to 50% Io, max		300	400	mV
Settling Time to 10% of Peak Deviation			25		μs
Turn-On Transient	lo=lo.max				
Start-Up Time, From On/Off Control	Von/off, Vo=10% of Vo,set		4	6	ms
Start-Up Time, From Input	Vin=Vin,min, Vo=10% of Vo,set		4	6	ms
Output Voltage Rise Time	Time for Vo to rise from 10% to 90% of Vo,set		4	8	ms
Maximum Output Startup Capacitive Load	Full load; ESR ≥1mΩ Full load; ESR ≥10mΩ			1000 5000	μ F μF
EFFICIENCY	Full load, ESR $\geq 1011\Omega$			5000	μr
Vo=3.3V	Vin=5V, 100% Load		95.0		%
Vo=2.5V	Vin=5V, 100% Load		93.0		%
V0=2.5V Vo=1.8V	Vin=5V, 100% Load		93.0 91.0		%
					%
Vo=1.5V	Vin=5V, 100% Load		89.5		
Vo=1.2V	Vin=5V, 100% Load		88.0		%
	Vin=5V, 100% Load		83.0		%
FEATURE CHARACTERISTICS			200		kH=
Switching Frequency			300		kHz
ON/OFF Control, (Negative logic)	Module On, Von/off	-0.2		0.3	V
Logic Low Voltage					V
Logic High Voltage Logic Low Current	Module Off, Von/off	1.5		Vin,max	
	Module On, Ion/off Module Off, Ion/off		0.2	10	μA
Logic High Current ON/OFF Control, (Positive Logic)			0.2	1	mA
Logic High Voltage	Module On, Von/off			Vin,max	V
Logic Low Voltage	Module Off, Von/off	-0.2		0.3	V
Logic Low Voltage	Module On, Ion/off	-0.2	0.2	1	mA
Logic Low Current	Module Off, Ion/off		0.2	10	μΑ
Tracking Slew Rate Capability		0.1		2	V/msec
Tracking Delay Time	Delay from Vin.min to application of tracking voltage	10		2	
Tracking Delay Time	Power-up 2V/mS	10	100	200	ms mV
	Power-down 1V/mS		200	400	mV
Remote Sense Range			200	0.1	V
GENERAL SPECIFICATIONS				0.1	v
GENERAL SPECIFICATIONS MTBF	lo=80%lo, max; Ta=25°C		11.88		M hours
Wight	10-00/00, 11ax, 1a-20 0		10		grams
		1	10	1	granis



ELECTRICAL CHARACTERISTICS CURVES

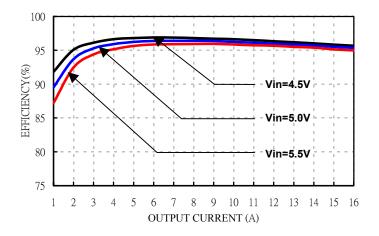


Figure 1: Converter efficiency vs. output current (3.3V out)

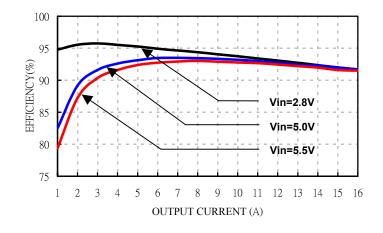


Figure 3: Converter efficiency vs. output current (1.8V out)

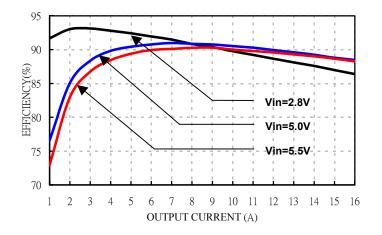


Figure 5: Converter efficiency vs. output current (1.2V out)

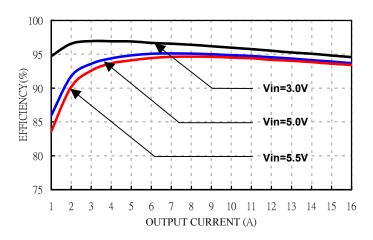


Figure 2: Converter efficiency vs. output current (2.5V out)

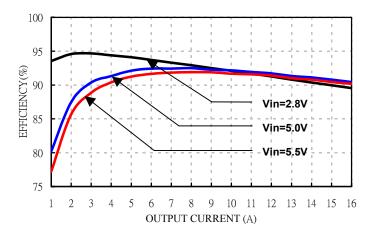


Figure 4: Converter efficiency vs. output current (1.5V out)

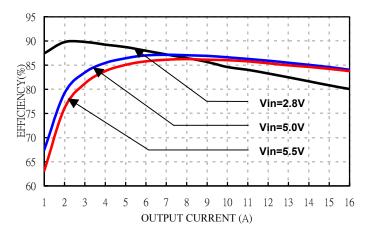
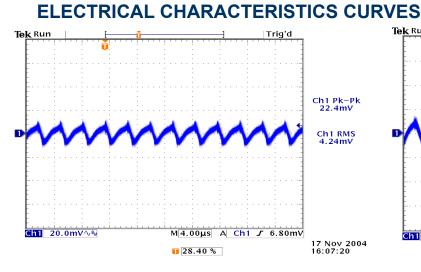
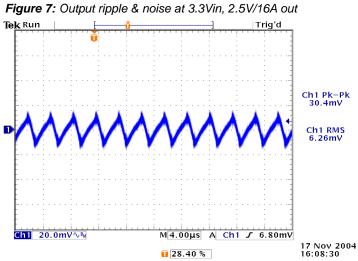
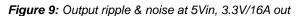


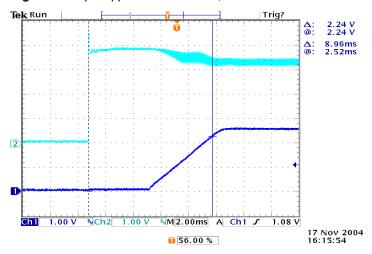
Figure 6: Converter efficiency vs. output current (0.75V out)

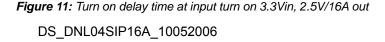


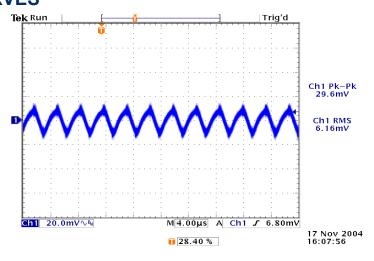


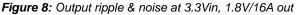


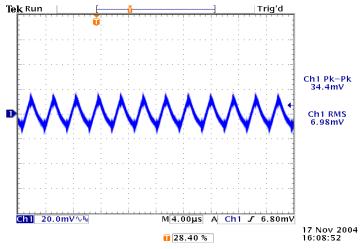


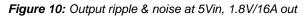


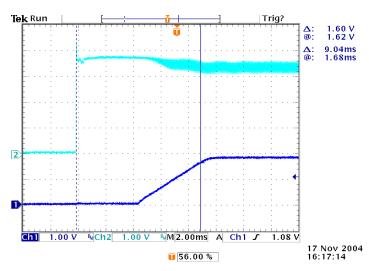


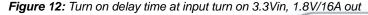


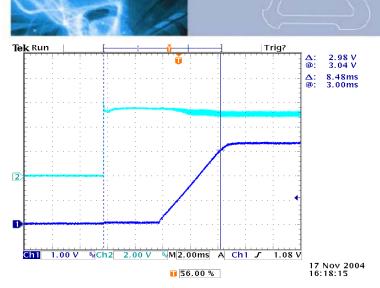


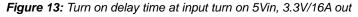












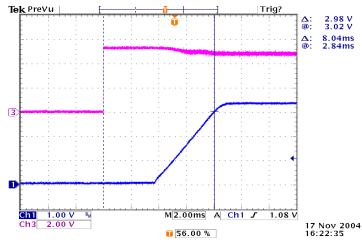


Figure 15: Turn on delay time at remote turn on 5Vin, 3.3V/16A out

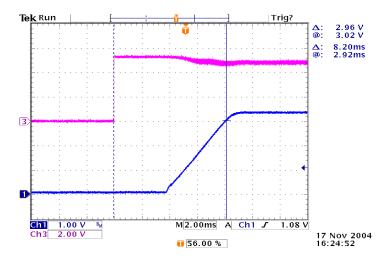


Figure 17: Turn on delay time at remote turn on with external capacitors (Co= 5000 μ F) 5Vin, 3.3V/16A out

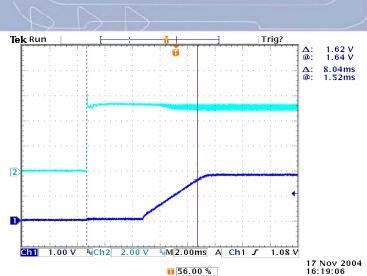


Figure 14: Turn on delay time at input turn on 5Vin, 1.8V/16A out

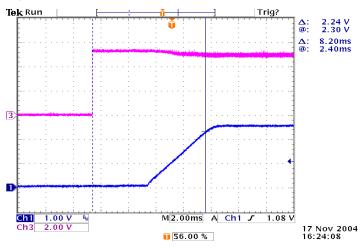


Figure 16: Turn on delay time at remote turn on 3.3Vin, 2.5V/16A

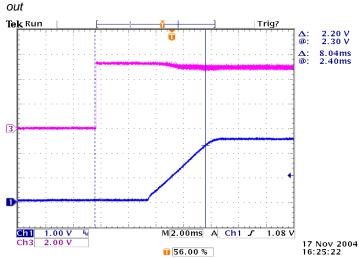


Figure 18: Turn on delay time at remote turn on with external capacitors (Co= 5000 μ F) 3.3Vin, 2.5V/16A out

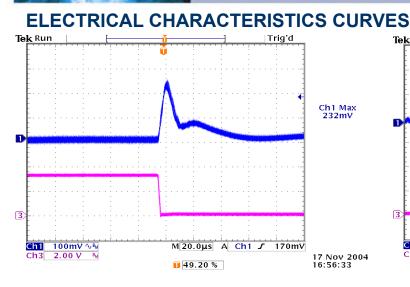


Figure 19: Typical transient response to step load change at 2.5A/ μ S from 100% to 50% of lo, max at 5Vin, 3.3V out (Cout = ceramic, 10 μ F tantalum)

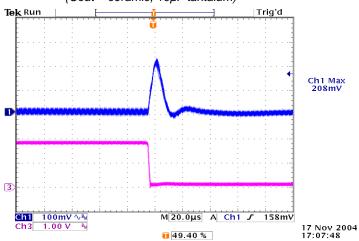


Figure 21: Typical transient response to step load change at 2.5A/ μ S from 100% to 50% of lo, max at 5Vin, 1.8V out (Cout = ceramic, 10 μ F tantalum)

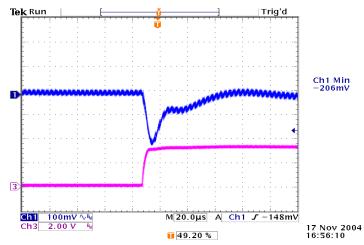


Figure 20: Typical transient response to step load change at 2.5A/ μ S from 50% to 100% of lo, max at 5Vin, 3.3V out (Cout = ceramic, 10 μ F tantalum)

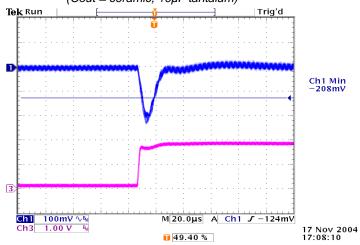


Figure 22: Typical transient response to step load change at 2.5A/ μ S from 50% to 100% of lo, max at 5Vin, 1.8V out (Cout = ceramic, 10 μ F tantalum)

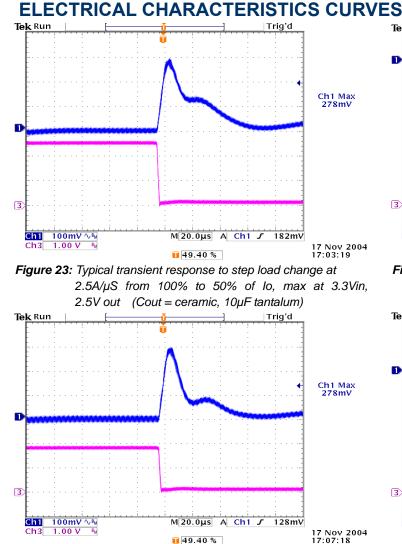


Figure 25: Typical transient response to step load change at 2.5A/µS from 100% to 50% of Io, max at 3.3Vin, 1.8V out (Cout = ceramic, 10μ F tantalum)

1 49.40 %

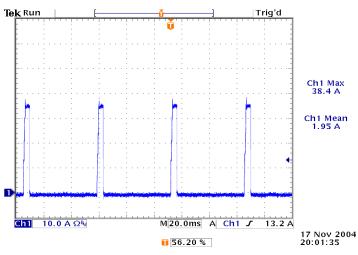


Figure 27: Output short circuit current 5Vin, 0.75Vout

DS_DNL04SIP16A_10052006

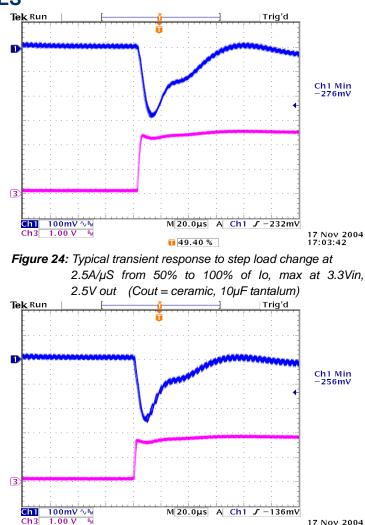
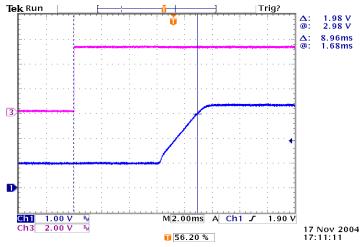
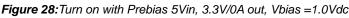


Figure 26: Typical transient response to step load change at 2.5A/µS from 50% to 100% of Io, max at 3.3Vin, 1.8V out (Cout = ceramic, 10μ F tantalum)

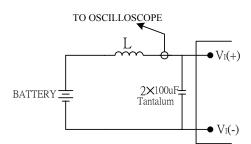
149.40 %





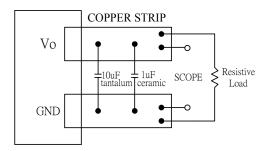
17 Nov 2004 17:06:58

TEST CONFIGURATIONS



Note: Input reflected-ripple current is measured with a simulated source inductance. Current is measured at the input of the module.

Figure 29: Input reflected-ripple test setup



Note: Use a 10μ F tantalum and 1μ F capacitor. Scope measurement should be made using a BNC connector.

Figure 30: Peak-peak output noise and startup transient measurement test setup.

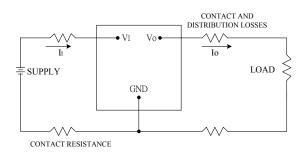


Figure 31: Output voltage and efficiency measurement test setup

Note: All measurements are taken at the module terminals. When the module is not soldered (via socket), place Kelvin connections at module terminals to avoid measurement errors due to contact resistance.

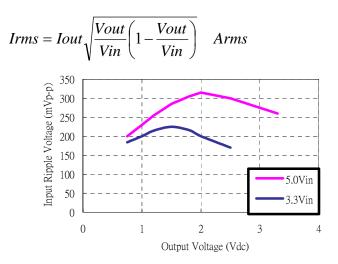
$$\eta = (\frac{Vo \times Io}{Vi \times Ii}) \times 100 \quad \%$$

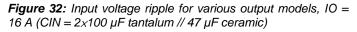
DESIGN CONSIDERATIONS

Input Source Impedance

To maintain low noise and ripple at the input voltage, it is critical to use low ESR capacitors at the input to the module. Figure 32 shows the input ripple voltage (mVp-p) for various output models using 200 μ F(2 x100uF) low ESR tantalum capacitor (KEMET p/n: T491D107M016AS, AVX p/n: TAJD107M106R, or equivalent) in parallel with 47 μ F ceramic capacitor (TDK p/n:C5750X7R1C476M or equivalent). Figure 33 shows much lower input voltage ripple when input capacitance is increased to 400 μ F (4 x 100 μ F) tantalum capacitors in parallel with 94 μ F (2 x 47 μ F) ceramic capacitor.

The input capacitance should be able to handle an AC ripple current of at least:





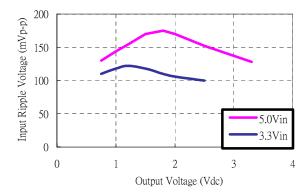


Figure 33: Input voltage ripple for various output models, IO = 16 A (CIN = 4×100 µF tantalum // 2×47 µF ceramic)



DESIGN CONSIDERATIONS (CON.)

The power module should be connected to a low ac-impedance input source. Highly inductive source impedances can affect the stability of the module. An input capacitance must be placed close to the modules input pins to filter ripple current and ensure module stability in the presence of inductive traces that supply the input voltage to the module.

Safety Considerations

For safety-agency approval the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standards.

For the converter output to be considered meeting the requirements of safety extra-low voltage (SELV), the input must meet SELV requirements. The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

The input to these units is to be provided with a maximum 20A of glass type fast-acting fuse in the ungrounded lead.

FEATURES DESCRIPTIONS

Remote On/Off

The DNM/DNL series power modules have an On/Off pin for remote On/Off operation. Both positive and negative On/Off logic options are available in the DNM/DNL series power modules.

For positive logic module, connect an open collector (NPN) transistor or open drain (N channel) MOSFET between the On/Off pin and the GND pin (see figure 34). Positive logic On/Off signal turns the module ON during the logic high and turns the module OFF during the logic low. When the positive On/Off function is not used, leave the pin floating or tie to Vin (module will be On).

For negative logic module, the On/Off pin is pulled high with an external pull-up resistor (see figure 35). Negative logic On/Off signal turns the module OFF during logic high and turns the module ON during logic low. If the negative On/Off function is not used, leave the pin floating or tie to GND. (module will be On)

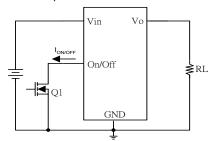


Figure 34: Positive remote On/Off implementation

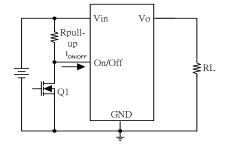


Figure 35: Negative remote On/Off implementation

Over-Current Protection

To provide protection in an output over load fault condition, the unit is equipped with internal over-current protection. When the over-current protection is triggered, the unit enters hiccup mode. The units operate normally once the fault condition is removed.





FEATURES DESCRIPTIONS (CON.)

Over-Temperature Protection

The over-temperature protection consists of circuitry that provides protection from thermal damage. If the temperature exceeds the over-temperature threshold the module will shut down. The module will try to restart after shutdown. If the over-temperature condition still exists during restart, the module will shut down again. This restart trial will continue until the temperature is within specification

Remote Sense

The DNL provide Vo remote sensing to achieve proper regulation at the load points and reduce effects of distribution losses on output line. In the event of an open remote sense line, the module shall maintain local sense regulation through an internal resistor. The module shall correct for a total of 0.5V of loss. The remote sense line impedance shall be < 10Ω .

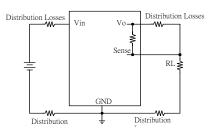


Figure 36: Effective circuit configuration for remote sense operation

Output Voltage Programming

The output voltage of the DNM/DNL can be programmed to any voltage between 0.75Vdc and 3.3Vdc by connecting one resistor (shown as Rtrim in Figure 37) between the TRIM and GND pins of the module. Without this external resistor, the output voltage of the module is 0.7525 Vdc. To calculate the value of the resistor Rtrim for a particular output voltage Vo, please use the following equation:

$$Rtrim = \left[\frac{21070}{Vo - 0.7525} - 5110\right]\Omega$$

For example, to program the output voltage of the DNL module to 1.8Vdc, Rtrim is calculated as follows:

$$Rtrim = \left[\frac{21070}{1.8 - 0.7525} - 5110\right]\Omega = 15K\Omega$$

DNL can also be programmed by apply a voltage between the TRIM and GND pins (Figure 38). The following equation can be used to determine the value of Vtrim needed for a desired output voltage Vo:

DS_DNL04SIP16A_10052006

 $Vtrim = 0.7 - 0.1698 \times (Vo - 0.7525)$

For example, to program the output voltage of a DNL module to 3.3 Vdc, Vtrim is calculated as follows

$$Vtrim = 0.7 - 0.1698 \times (3.3 - 0.7525) = 0.267V$$

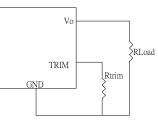


Figure 37: Circuit configuration for programming output voltage using an external resistor

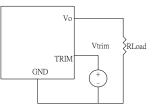


Figure 38: Circuit configuration for programming output voltage using external voltage source

Table 1 provides Rtrim values required for some common output voltages, while Table 2 provides value of external voltage source, Vtrim, for the same common output voltages. By using a 1% tolerance trim resistor, set point tolerance of $\pm 2\%$ can be achieved as specified in the electrical specification.

Table	1
-------	---

Vo(V)	Rtrim(KΩ)
0.7525	Open
1.2	41.97
1.5	23.08
1.8	15.00
2.5	6.95
3.3	3.16

Table Z	Та	b	le	2
---------	----	---	----	---

Vo(V)	Vtrim(V)
0.7525	Open
1.2	0.624
1.5	0.573
1.8	0.522
2.5	0.403
3.3	0.267



FEATURE DESCRIPTIONS (CON.)

The amount of power delivered by the module is the voltage at the output terminals multiplied by the output current. When using the trim feature, the output voltage of the module can be increased, which at the same output current would increase the power output of the module. Care should be taken to ensure that the maximum output power of the module must not exceed the maximum rated power (Vo.set x lo.max \leq P max).

Voltage Margining

Output voltage margining can be implemented in the DNL modules by connecting a resistor, R margin-up, from the Trim pin to the ground pin for margining-up the output voltage and by connecting a resistor, Rmargin-down, from the Trim pin to the output pin for margining-down. Figure 39 shows the circuit configuration for output voltage margining. If unused, leave the trim pin unconnected. A calculation tool is available from the evaluation procedure which computes the values of R margin-up and Rmargin-down for a specific output voltage and margin percentage.

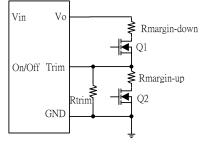


Figure 39: Circuit configuration for output voltage margining

Voltage Tracking

The DNM/DNL family was designed for applications that have output voltage tracking requirements during power-up and power-down. The devices have a TRACK pin to implement three types of tracking method: sequential, ratio-metric and simultaneous. TRACK simplifies the task of supply voltage tracking in a power system by enabling modules to track each other, or any external voltage, during power-up and power-down.

By connecting multiple modules together, customers can get multiple modules to track their output voltages to the voltage applied on the TRACK pin.

The DNL family has 3 different option codes for TRACK function:

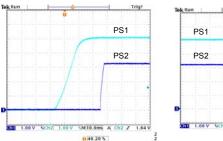
DS_DNL04SIP16A_10052006

The DNL family has 3 different option codes for TRACK function.

Option code A: the output voltage TRACK characteristic can be achieved when the output voltage of PS2 follows the output voltage of PS1 on a volt-to-volt basis. (Figure 41)

Option code B: No TRACK function

Option code C: Implementation of advanced power tracking techniques is based on connecting the power good signal or selecting proper value for external resistor R1 (Figure 40 to Figure 43).



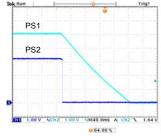
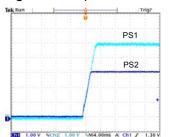
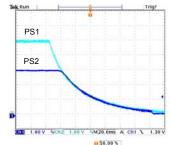
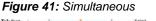


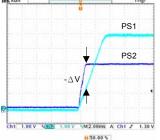
Figure 40: Sequential

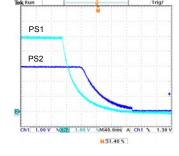




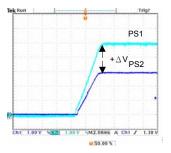












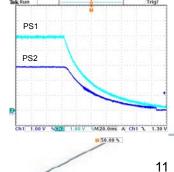


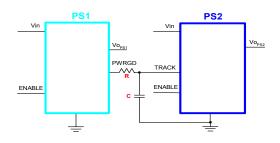
Figure 43: Ratio-metric



FEATURE DESCRIPTIONS (CON.)

Sequential

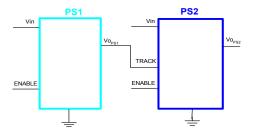
Sequential start-up (Figure 40) is implemented by connecting the power good pin of PS1 to the TRACK pin of PS2 with a resistor–capacitor (RC) circuit. Suggest to use 1μ F ceramic capacitor and $2K\Omega$ resistor here. Besides, this configuration requires PS1 to have a power good function.



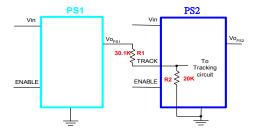
Simultaneous

Simultaneous tracking (Figure 41) is implemented by using a voltage divider around the TRACK pin. The objective is to minimize the voltage difference between the power supply outputs during power up and down.

For type A (DNX0A0XXXX **A**), the simultaneous tracking can be accomplished by connecting Vo_{PS1} to the TRACK pin of PS2 where the voltage divider is inside the PS2.



For type C (DNX0A0XXXX C), the simultaneous tracking can be accomplished by putting R1 equal to $30.1K\Omega$ through Vo_{PS1} to the TRACK pin of PS2.



DS_DNL04SIP16A_10052006

Ratio-Metric

Ratio–metric is implemented by selecting the resistor values of the voltage divider on the TRACK pin. To simplify the tracking design, set initial value of R2 equal to $20K\Omega$ at internal circuit and adjust resistor R1 for the different tracking method. The circuit diagram of Ratio-Metric is the same as **Simultaneous** when Vo_{PS2} tracks the Vo_{PS1}.

For Ratio-Metric applications that need the outputs of PS1 and PS2 go to the regulation set point at the same time (Figure 43), use the following equation (1) to calculate the value of resistor R1,

set $\triangle V=Vo_{set,PS1}-Vo_{set,PS2}$ and $\triangle V$ will be negative.

$$R1 = \frac{\left[(Vo_{set,PS2} + \Delta V) - Vref\right]}{Vref} * 20K\Omega \quad -----(1)$$

Note:

- 1. Vref =0.4×Vo_{set,PS2}
- 2. $\triangle V$ is the maximum difference of voltage between PS1 and PS2 supply voltage.

For Ratio-Metric applications that need the PS2 supply voltage rises first at power up and falls second at power down (Figure 42), use the following equation (2) to calculate the value of resistor R1,

set $\triangle V \leq 0.4 \times Vo_{set,PS2}$ and $\triangle V$ will be negative.

Note:

1. Vref =0.4×Vo_{set,PS2}

 $\triangle V$ is defined as the voltage difference between Vo_{PS1} and Vo_{PS2} when Vo_{PS2} reaches its rated voltage.



THERMAL CONSIDERATIONS

Thermal management is an important part of the system design. To ensure proper, reliable operation, sufficient cooling of the power module is needed over the entire temperature range of the module. Convection cooling is usually the dominant mode of heat transfer.

Hence, the choice of equipment to characterize the thermal performance of the power module is a wind tunnel.

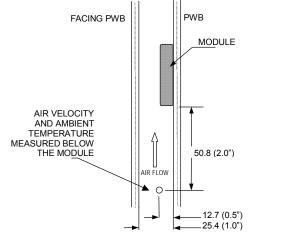
Thermal Testing Setup

Delta's DC/DC power modules are characterized in heated vertical wind tunnels that simulate the thermal environments encountered in most electronics equipment. This type of equipment commonly uses vertically mounted circuit cards in cabinet racks in which the power modules are mounted.

The following figure shows the wind tunnel characterization setup. The power module is mounted on a test PWB and is vertically positioned within the wind tunnel. The height of this fan duct is constantly kept at 25.4mm (1").

Thermal Derating

Heat can be removed by increasing airflow over the module. To enhance system reliability, the power module should always be operated below the maximum operating temperature. If the temperature exceeds the maximum module temperature, reliability of the unit may be affected.



Note: Wind Tunnel Test Setup Figure Dimensions are in millimeters and (Inches)

Figure 44: Wind tunnel test setup

THERMAL CURVES

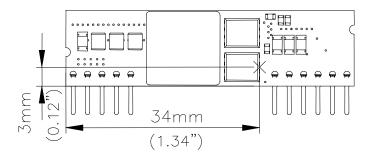
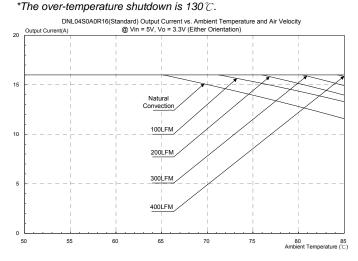
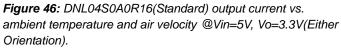


Figure 45: Hot spot temperature measured point *The allowed maximum hot spot temperature is defined at $125 \degree$





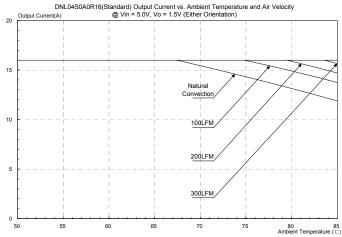


Figure 47: DNL04S0A0R16(Standard) output current vs. ambient temperature and air velocity @Vin=5V, Vo=1.5V(Either Orientation).

THERMAL CURVES (CON.)

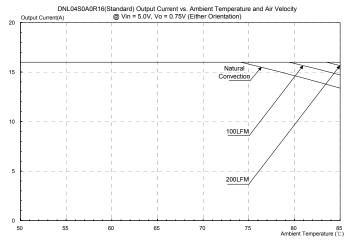


Figure 48: DNL04S0A0R16(Standard) output current vs. ambient temperature and air velocity @Vin=5V, Vo=0.75V(Either Orientation).

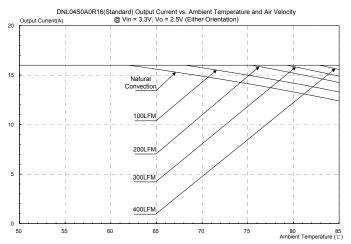


Figure 49: DNL04S0A0R16(Standard) output current vs. ambient temperature and air velocity @Vin=3.3V, Vo=2.5V(Either Orientation).

DNL04S0A0R16(Standard) Output Current vs. Ambient Temperature and Air Velocity t(A) @ Vin = 3.3V, Vo = 1.5V (Either Orientation) Output Current(A) 20 15 Natural Convection 10 100LFM 200LFM 300LFM 55 60 65 70 75 80 85 Ambient Temperature (°C)

Figure 50: DNL04S0A0R16(Standard) output current vs. ambient temperature and air velocity @Vin=3.3V, Vo=1.5V(Either Orientation).

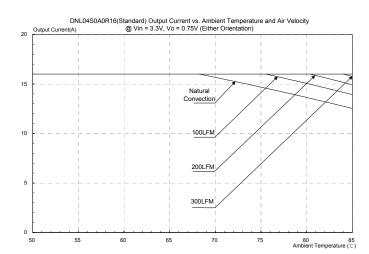


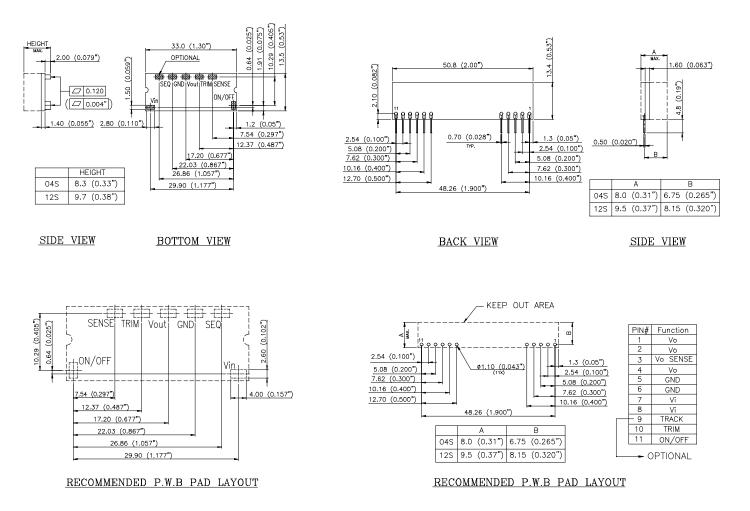
Figure 51: DNL04S0A0R16(Standard) output current vs. ambient temperature and air velocity @Vin=3.3V, Vo=0.75V(Either Orientation).





SMD PACKAGE (OPTIONAL)

SIP PACKAGE



NOTES: DIMENSIONS ARE IN MILLIMETERS AND (INCHES) TOLERANCES: X.Xmm±0.5mm(X.XX in.±0.02 in.) X.XXmm±0.25mm(X.XXX in.±0.010 in.)





PART NUMBERING SYSTEM

DNL	04	S	0A0	R	16	Р	F	А
Product Series	Input Voltage	Numbers of Outputs	Output Voltage	Package Type	Output Current	On/Off logic		Option Code
DNL – 16A	04 - 2.8~5.5V	S - Single	0A0 -	R - SIP	16 -16A	N- negative	F- RoHS 6/6	A - Standard
DNM – 10A	12 - 9~14V		Programmable	S - SMD		P- positive	(Lead Free)	Function:
DNS – 6A								Sequencing
								B - No tracking pin
								C - Tracking feature

MODEL LIST

Model Name	Packaging	Input Voltage	Output Voltage	Output Current	Efficiency 5.0Vin @ 100% load
DNL04S0A0S16PFA	SMD	2.8 ~ 5.5Vdc	0.75~3.3Vdc	16A	95.0%
DNL04S0A0R16PFA	SIP	2.8 ~ 5.5Vdc	0.75~3.3Vdc	16A	95.0%

CONTACT: www.delta.com.tw/dcdc

USA:	Europe:
Telephone: East Coast: (888) 335 8201	Phone: +41 3
West Coast: (888) 335 8208 Fax: (978) 656 3964	Fax: +41 31 9 Email: <u>DCDC</u>
Email: <u>DCDC@delta-corp.com</u>	

Europe: Phone: +41 31 998 53 11 Fax: +41 31 998 53 53 Email: <u>DCDC@delta-es.com</u> **Asia & the rest of world:** Telephone: +886 3 4526107 ext 6220 Fax: +886 3 4513485 Email: <u>DCDC@delta.com.tw</u>

WARRANTY

Delta offers a two (2) year limited warranty. Complete warranty information is listed on our web site or is available upon request from Delta.

Information furnished by Delta is believed to be accurate and reliable. However, no responsibility is assumed by Delta for its use, nor for any infringements of patents or other rights of third parties, which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Delta. Delta reserves the right to revise these specifications at any time, without notice.